



RE014-LF

- SMD-Labcard
- Epoxy fibre-glass 1.50 mm
- Single-sided 35 µm Cu
- Hot air leveling (HAL-Leadfree)
- 75 x 75 soldering pads 1.00 x 1.00 mm
- Hole spacing 1,27 x 1,27 mm
- Hole diameter 0.45 mm
- Size 99.06 x 99.69 mm